

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S2	329	S1 and electroplat\$	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/13 14:34
S1	1920	("204" "205").clas. and porous with ceramic	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/13 14:34
S3	213	S2 and (semiconductor wafer electronic microelectronic microfeature)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/13 14:53
S6	43	("4435266").URPN.	USPAT	OR	ON	2007/03/13 15:02
S5	3	"4435266".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/13 15:02
S4	11	S3 and ebara	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/13 15:02
S7	43	("4435266").URPN.	USPAT	OR	ON	2007/03/13 15:07
S9	10	("20010000477"   "4696729"   "5443707"   "5597460"   "5932076"   "6024856"   "6059885"   "6475627"   "6539963"   "6655829").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/13 15:27
S14	1	"01012882"	EPO; DERWENT	OR	ON	2007/03/13 15:28
S13	41	"0112882"	EPO; DERWENT	OR	ON	2007/03/13 15:28
S12	2	"0112882"	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/13 15:28
S11	0	"200112882"	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/13 15:28
S10	0	"2001012882"	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/13 15:28
S15	3	"2001012882"	EPO; DERWENT	OR	ON	2007/03/13 15:29

## EAST Search History

S8	288	wilkins\$-h\$.xa. wilkins\$-h\$.xp. and ("204" "205").clas.	USPAT	OR	ON	2007/03/13 16:07
S16	3	"200112882"	EPO; DERWENT	OR	ON	2007/03/14 13:45
L2	2	"6949172".pn.	USPAT; EPO; DERWENT	OR	ON	2007/03/14 13:45
L7	17	ebara and high adj resistance adj structure	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/14 14:07
L9	341	bubble with removal and ("204" "205").clas.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/14 14:37
L14	31	tilt with head and ("204" "205").clas.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/14 15:59
L13	0	tilt same wafer adj head and ("204" "205").clas.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/14 15:59
L12	0	tilt with wafer adj head and ("204" "205").clas.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/14 15:59
L10	2	"20040256238"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/14 15:59
L15	2	"20020020627".pn.	US-PGPUB; EPO; DERWENT	OR	ON	2007/03/14 16:36
L8	12	high adj resistance adj structure and ("204" "205").clas.	US-PGPUB	OR	ON	2007/03/14 16:36

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	385	electroplat\$ and flow with lateral	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/14 16:38
L2	532	electroplat\$ and flow with lateral\$2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/14 16:39
L3	463	L2 and (substrate wafer semiconductor electronic microelectronic)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/14 16:39
L4	80	L3 and ("204" "205").clas.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/14 16:39